

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONG-SEN CHEN	04/07/2021
YU-JU KUO	04/07/2021
YUNG-LUNG TSENG	04/07/2021
CHUN-WEI SU	04/07/2021
RECEIVING PARTY DATA	
Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
Street Address:	NO. 195, SEC. 4, CHUNG HSING RD., CHUTUNG
City:	HSINCHU
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17139336
CORRESPONDENCE DATA	
Fax Number:	(703)205-8050
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-205-8000
Email:	tu.t.tan@bskb.com, mailroom@bskb.com
Correspondent Name:	BIRCH, STEWART, KOLASCH & BIRCH, LLP
Address Line 1:	8110 GATEHOUSE ROAD, SUITE 100E
Address Line 4:	FALLS CHURCH, VIRGINIA 22042
ATTORNEY DOCKET NUMBER:	0941-4511PUS1
NAME OF SUBMITTER:	TAN T. TU
SIGNATURE:	/TAN T. TU/
DATE SIGNED:	04/09/2021
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, Dong-Sen CHEN, Yu-Ju KUO, Yung-Lung TSENG and Chun-Wei SU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Polymer composition, and polysiloxane-polyimide material thereof

Filed: December 31, 2020 Serial No. 17/139,336

Executed on: April 7, 2021

WHEREAS, INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, and the entire rights, title and interest in and to any and all foreign patents and applications for any invention described in said U.S. patent applications, in any and all countries foreign to the U.S., including all rights of priority arising from them, and all the rights and privileges under any and all forms of protection, including patents, that may be granted in said countries foreign to the U.S. for them, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

2021.04.07 Dong-Sen Chen
 Date Name: Dong-Sen CHEN

2021.04.07 Yu-Ju KUO
 Date Name: Yu-Ju KUO

ASSIGNMENT

2021.04.07
Date

蔡子昂 Yung-Lung Tseng
Name: Yung-Lung TSENG

2021.4.7
Date

蘇俊奇 Chun-Wei Su
Name: Chun-Wei SU